

### • Application

- \* LCD back light
- \* Switch back lights
- \* Illuminations.

DRAWING NO. : DS-73-16-004

# SURFACE MOUNT DEVICE LED

## Part No. : L-S110WDT-LCFC

REV:A/1

### • CHIP MATERIALS

- \* Dice Material : InGaN
- \* Light Color : White
- \* Lens Color : Light Yellow Diffused.

## • Absolute Maximum Ratings(Ta=25°C)

Symbol	Parameter	Rating	Unit
PD	Power Dissipation	80	mW
Ipf	Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	60	mA
IF	Continuous Forward Current	20	mA
VR	Reverse Voltage	5	V
ESD	Electrostatic Discharge Threshold(HBM) <sup>Note A</sup>	1000	V
Topr	Operating Temperature Range	-40 ~ +85	°C
Tstg	Storage Temperature Range	-40 ~ +85	°C

Note A :

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

## • Electro-Optical Characteristics(Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition	
Luminous Intensity	IV	45	90	180	mcd	IF=5mA	
Viewing Angle	2 <del>0</del> 1/2		130		Deg	Note 2	
CIE Chromaticity	X		0.270			IE 5 m A	
CIE Chromaticity	Y		0.255			IF=5mA	
Forward Voltage	VF	2.6	2.8	3.1	V	IF = 5mA	
Reverse Current	IR			50	μA	VR = 5V	

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### • Bin Code List

Luminous Intensity(IV), Unit:mcd@5mA					
Bin Code	Min	Max			
Р	45	71			
Q	71	112			
R	112	180			

Forward Voltage(VF), Unit:V@5mA						
Bin Code	Min	Max				
11	2.6	2.7				
12	2.7	2.8				
13	2.8	2.9				
14	2.9	3.0				
15	3.0	3.1				

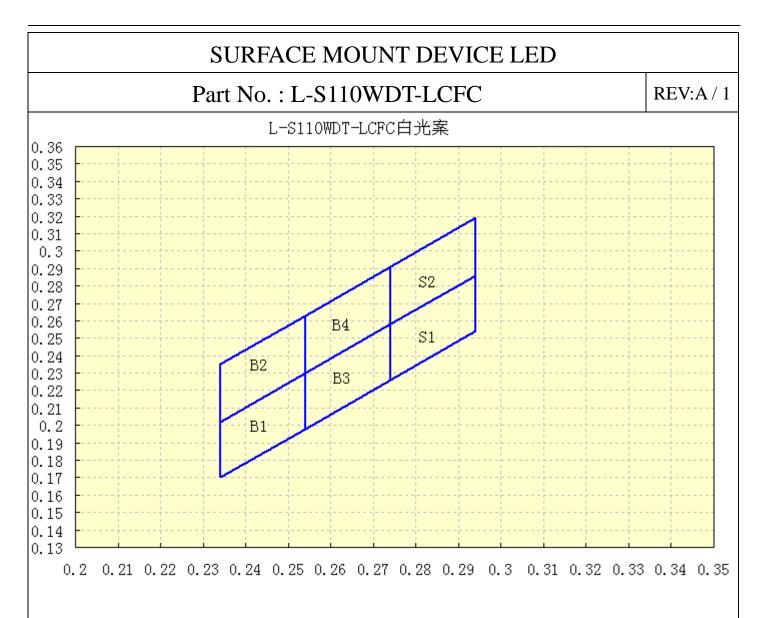
Tolerance of each bin are  $\pm 15\%$ 

Tolerance of each bin are  $\pm 0.1$  Volt

Color Rank (CIE chromaticity X, Y) @ 5mA									
Rank B1				Rank B2					
X	0.234	0.234	0.254	0.254	Х	0.234	0.234	0.254	0.254
Y	0.17	0.202	0.23	0.198	Y	0.202	0.235	0.263	0.23
Rank B3				Rank B4					
X	0.254	0.254	0.274	0.274	Х	0.254	0.254	0.274	0.274
Y	0.23	0.198	0.226	0.258	Y	0.23	0.263	0.291	0.258
Rank S1				Rank S2					
X	0.274	0.274	0.294	0.294	Х	0.274	0.274	0.294	0.294
Y	0.226	0.258	0.286	0.254	Y	0.258	0.291	0.319	0.286

\* Measurement of Color coordinates : +/- 0.02

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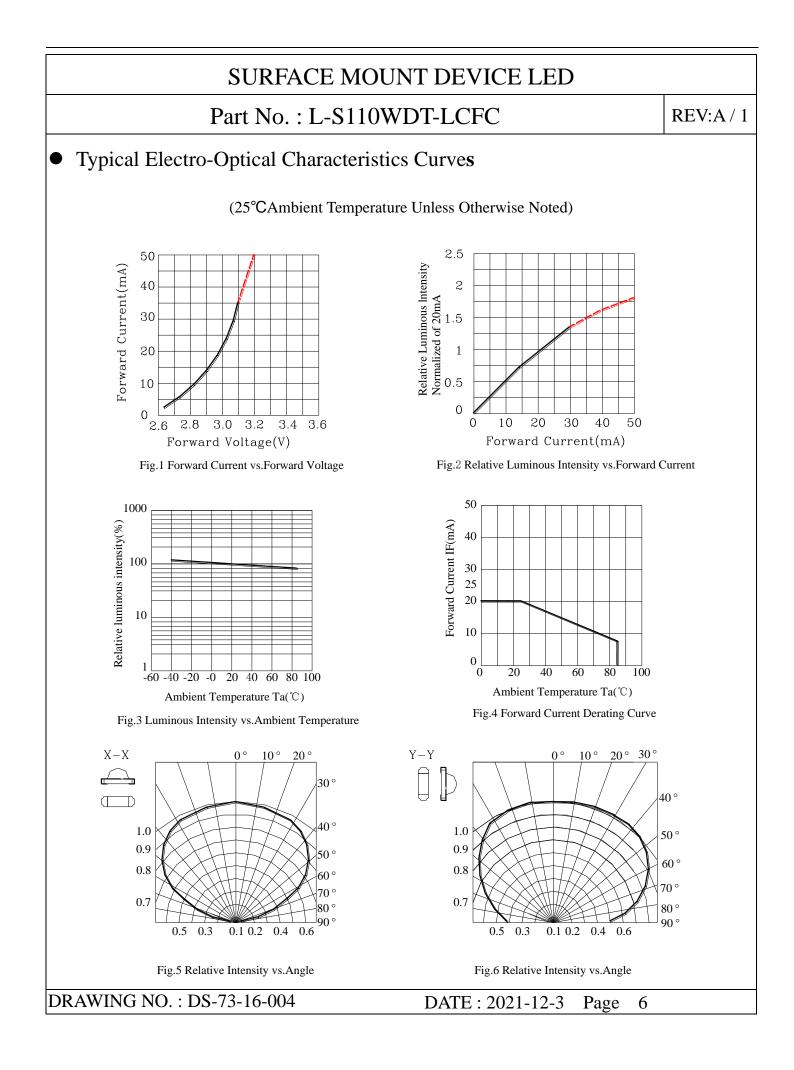
Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2.  $\theta$  1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength  $\lambda$  d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD :

Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

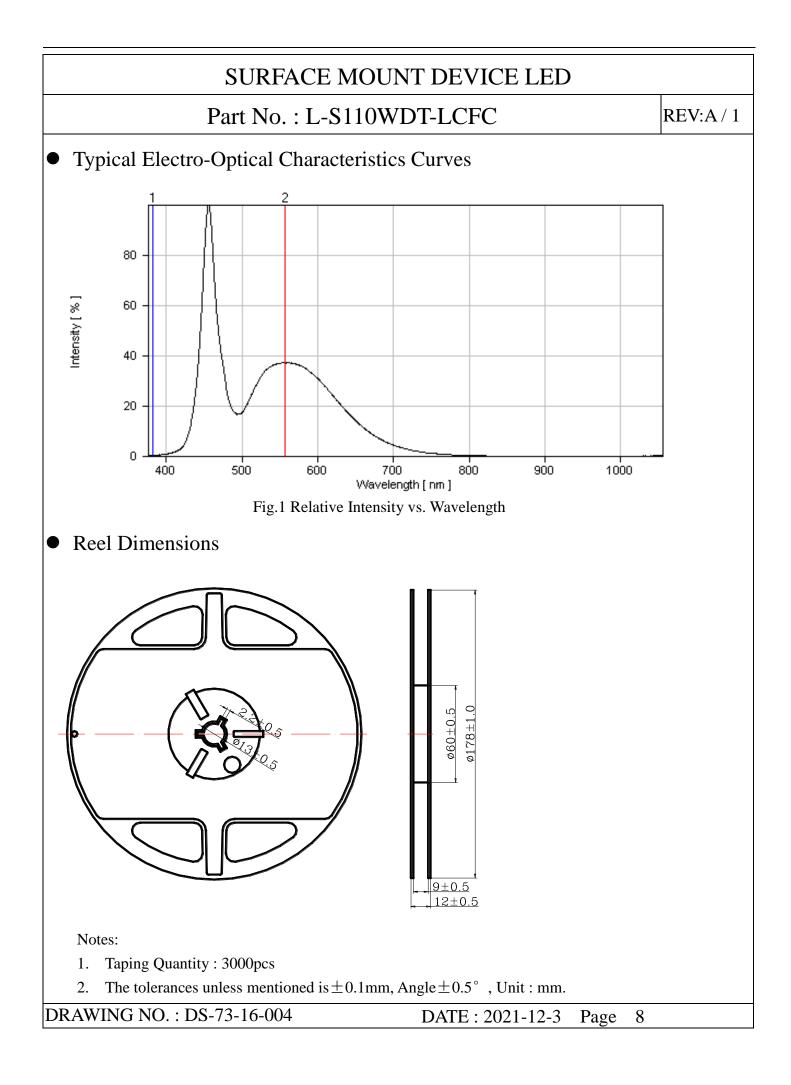
5. Major standard testing equipment by "Instrument System" Model : CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model : 2400.

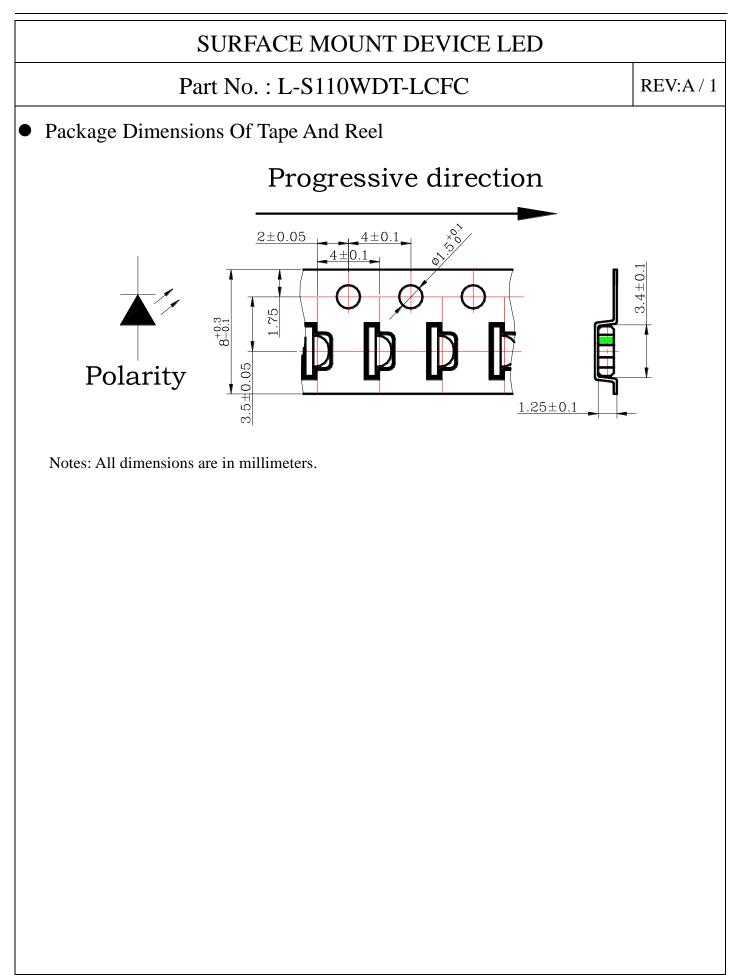
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#### SURFACE MOUNT DEVICE LED Part No. : L-S110WDT-LCFC REV:A/1 • Label Explanation CUS.PART NO: CUSTOMER: PART NO: IV: LOT NO: VF: CIE: QUANTITY: QC: DATE CODE: RoHS ITEM CODE:PARA LIGHT PART NO: L-S110WDT-LCFC IV --- Luminous Intensity Code LOT NO: EM S L 12 09 0110 в F А С D Е A---EM: Emos Code B---S:SMD L---Local D---Year E---Month F---SPEC. PACKING QUANTITY OF BAG: 3000pcs for 150, 170, 110, 155, 115 series 4000pcs for 191 series 5000pcs for 192 series DATE CODE: <u>2012</u> <u>09</u> <u>10</u> G Η Ι G---- Year H--- Month I --- Day

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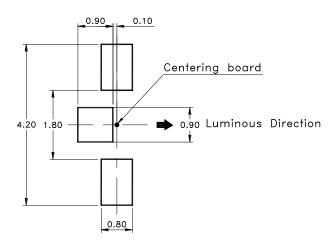
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# SURFACE MOUNT DEVICE LED Part No. : L-S110WDT-LCFC

## • Cleaning

- \* If cleaning is required, use the following solutions for less than 1 minute and less than  $40^{\circ}$ C.
- \* Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- \* Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

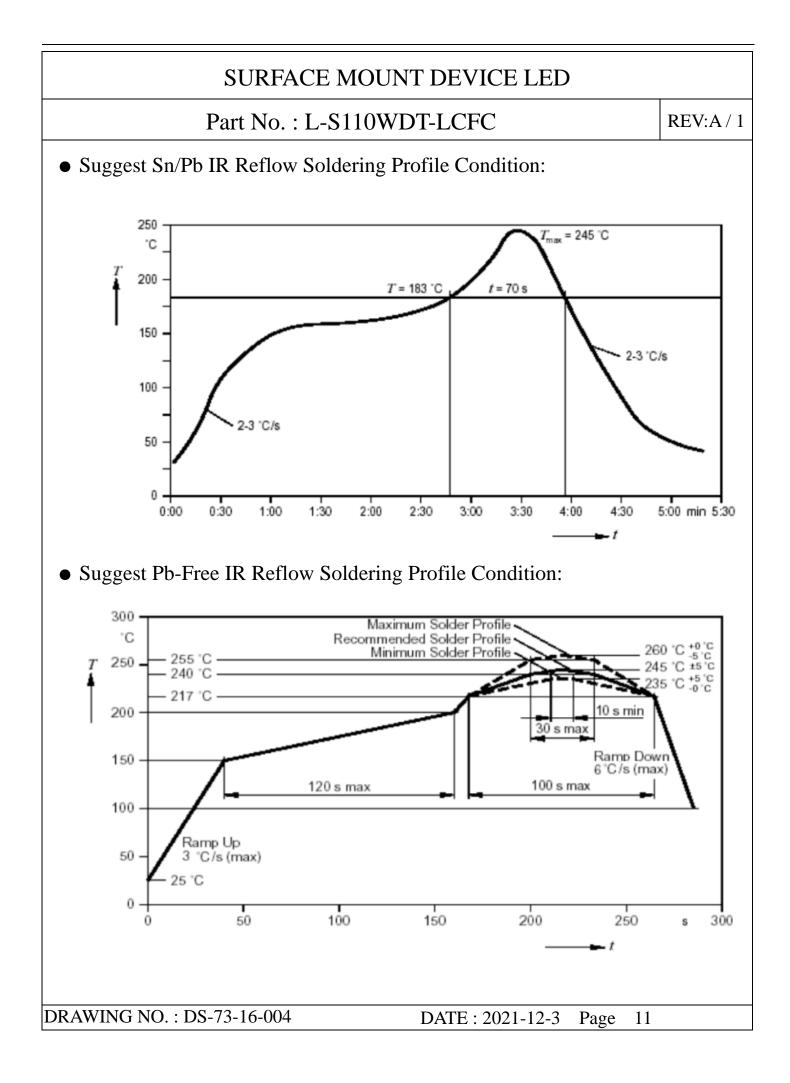
## Suggest Soldering Pad Dimensions



Direction of PWB camber

and go to reflow furnace

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# SURFACE MOUNT DEVICE LED

### Part No. : L-S110WDT-LCFC

#### • CAUTIONS

#### 1. Application Limitation :

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application).Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

#### 2.Storage :

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment:  $60\pm5$  °C for 24 hours

### 3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering condition.

Reflow Soldering :

Pre-heat 120~150 °C, 120sec. MAX., Peak temperature : 240 °C Max. Soldering time : 10 sec Max. Soldering Iron : (Not recommended)

Temperature 300 °C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering. Wave soldering :

Pre-heat 100  $^{\circ}$  Max, Pre-heat time 60 sec. Max, Solder wave 260  $^{\circ}$  Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.

SURFACE MOUNT DEVICE LED					
Part No. : L-S110WI	DT-LCFC	REV:A/1			
	OVER 230°C,40sec.Max. 4.1 Bi /0.5 Cu Circuit model B				
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